

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING THE SAME		
Application Number :			
Date :			
First Named Applicant:		Min-Jer Lin	
Confirmation Number:			
Attorney Docket Number:		LKSP0027USA	
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Submitted By:		Elec. Sign.	
Winston Hsu Registered Number: 41,526		Winston Hsu	

Documents being submitted:	Files
us-fee-sheet	LKSP0027_0_A1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	LKSP0027_0_A1-usdecl.xml us-declaration.dtd us-declaration.xsl
us-power-of-attorney-grant	LKSP0027_0_A1-uspoat.xml us-power-of-attorney-grant.dtd us-power-of-attorney-grant.xsl
us-assignment	LKSP0027_0_A1-usassn.xml us-assignment.xsl us-assignment.dtd LKSP0027_0_A1ASS1.tif
us-request	LKSP0027_0_A1-usrequ.xml us-request.dtd us-request.xsl
application-body	LKSP0027-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd Lksp0027usa-01.tif Lksp0027usa-02.tif Lksp0027usa-03.tif Lksp0027usa-04.tif Lksp0027usa-05.tif

	Lksp0027usa-06.tif
	Lksp0027usa-07.tif
	Lksp0027usa-08.tif
	Lksp0027usa-09.tif
	Lksp0027usa-10.tif
	Lksp0027usa-11.tif
	Lksp0027usa-12.tif
us-declaration	LKSP0027_0_A1DEC1.tif
us-declaration	LKSP0027_0_A1DEC2.tif
Comments	